

GP1A57HRJ00F

Gap : 10mm, Slit : 1.8mm
 *OPIC Output
 Case package Transmissive
 Photointerrupter



■ Description

GP1A57HRJ00F is a standard, OPIC output, transmissive photointerrupter with opposing emitter and detector in a case, providing non-contact sensing. For this family of devices, the emitter and detector are inserted in a case, resulting in a through-hole design.

This device has a wide gap.

■ Features

1. Transmissive with OPIC output
2. Highlights :
 - Vertical Slit for alternate motion detection
 - Output Low Level at intercepting optical path
 - Wide gap width (10mm)
 - Positioning Pin to prevent misalignment
3. Key Parameters :
 - Gap Width : 10mm
 - Slit Width (detector side) : 1.8mm
 - Package : 18.6×15.2×5mm
4. Lead free and RoHS directive compliant

■ Agency approvals/Compliance

1. Compliant with RoHS directive

■ Applications

1. General purpose detection of object presence or motion.
2. Example : Printer, FAX, Optical storage unit

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* "OPIC"(Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and a signal-processing

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Date code (2 digit)

1st digit		2nd digit	
Year of production		Month of production	
A.D.	Mark	Month	Mark
2000	0	1	1
2001	1	2	2
2002	2	3	3
2003	3	4	4
2004	4	5	5
2005	5	6	6
2006	6	7	7
2007	7	8	8
2008	8	9	9
2009	9	10	X
2010	0	11	Y
:	:	12	Z

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repeats in a 10 year cycle

Country of origin

Japan, Indonesia or Philippines
 (Indicated on the packing case)

■ Absolute Maximum Ratings

 (T_a=25°C)

	Parameter	Symbol	Rating	Unit
Input	*1 Forward current	I _F	50	mA
	*1,2 Peak forward current	I _{FM}	1	A
	Reverse voltage	V _R	6	V
	Power dissipation	P	75	mW
Output	Supply voltage	V _{CC}	-0.5 to +17	V
	Output current	I _O	50	mA
	Power dissipation	P _O	250	mW
	Operating temperature	T _{opr}	-25 to +85	°C
	Storage temperature	T _{stg}	-40 to +100	°C
	*3 Soldering temperature	T _{sol}	260	°C

*1 Refer to Fig. 1, 2, 3

*2 Pulse width ≤ 100μs, Duty ratio=0.01

*3 For 5s or less

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■ Electro-optical Characteristics

 (T_a=25°C)

	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage	V _F	I _F =7mA	-	1.14	1.4	V	
	Reverse current	I _R	V _R =3V	-	-	10	μA	
Output	Operating supply voltage	V _{CC}	-	4.5	-	17	V	
	Low level output voltage	V _{OL}	V _{CC} =5V, I _{OL} =16mA, I _F =0	-	0.15	0.4	V	
	High level output voltage	V _{OH}	V _{CC} =5V, I _F =7mA	4.9	-	-	V	
	Low level supply current	I _{CCL}	V _{CC} =5V, I _F =0	-	1.7	3.8	mA	
	High level supply current	I _{CCH}	V _{CC} =5V, I _F =7mA	-	0.7	2.2	mA	
Transfer characteristics	*4 "Low→High" threshold input current	I _{FLH}	V _{CC} =5V	-	1	7	mA	
	*5 Hysteresis	I _{FHL} /I _{FLH}	V _{CC} =5V	0.55	0.75	0.95	-	
	*6 Response time	"Low→High" Propagation delay time	t _{PLH}	V _{CC} =5V, I _F =7mA, R _L =280Ω	-	3	9	μs
		"High→Low" Propagation delay time	t _{PHL}		-	5	15	
		Rise time	t _r		-	0.1	0.5	
Fall time		t _f	-		0.05	0.5		

 *4 I_{FLH} represents forward current when output goes from "Low" to "High".

 *5 I_{FHL} represents forward current when output goes from "High" to "Low".

*6 Test circuit for response time is shown in Fig.12.

Fig.1 Forward Current vs. Ambient Temperature

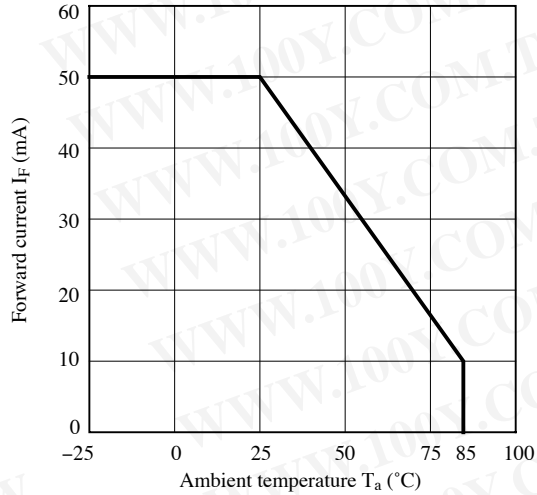


Fig.2 Output Power Dissipation vs. Ambient Temperature

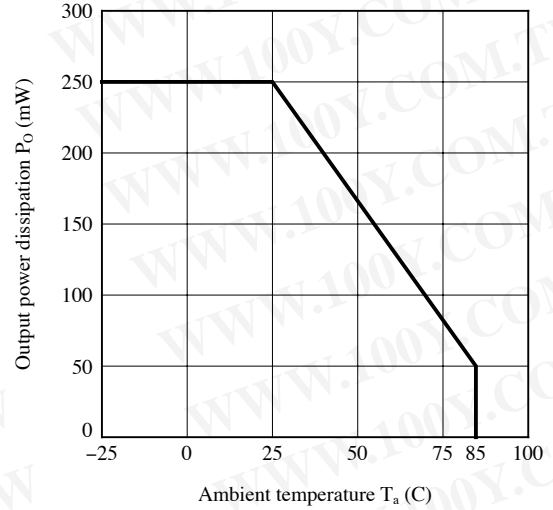


Fig.3 Low Level Output Current vs. Ambient Temperature

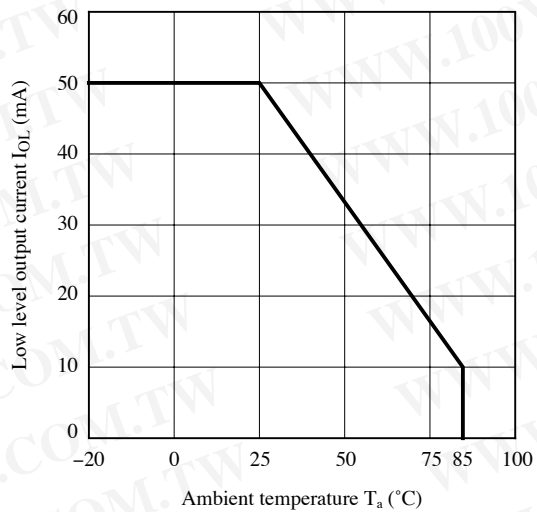


Fig.4 Forward Current vs. Forward Voltage

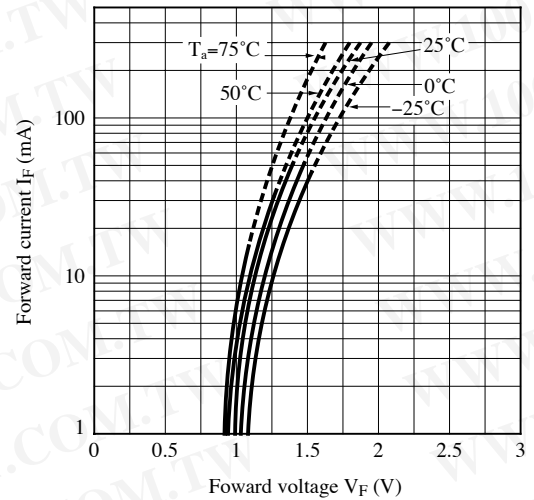


Fig.5 Relative Threshold Input Current vs. Supply Voltage

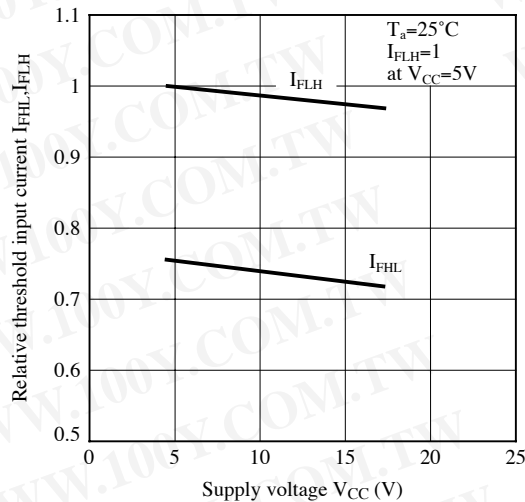


Fig.6 Relative Threshold Input Current vs. Ambient Temperature

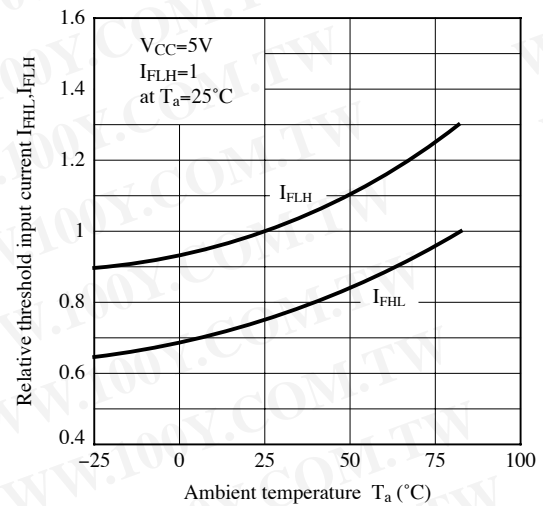


Fig.7 Low Level Output Voltage vs. Low Level Output Current

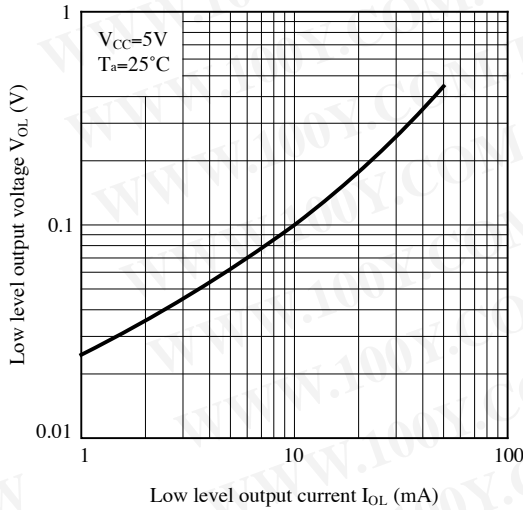


Fig.8 Low Level Output Voltage vs. Ambient Temperature

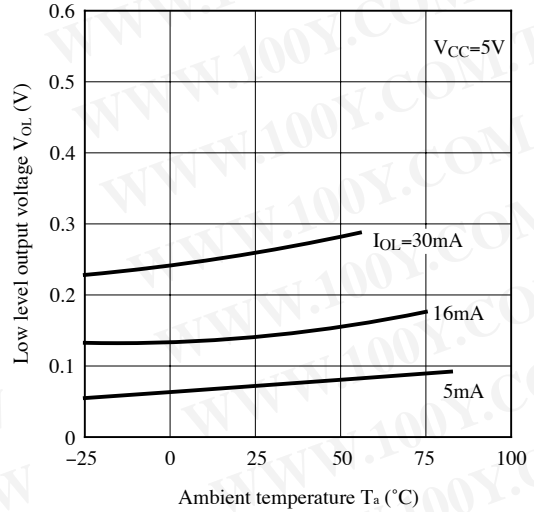


Fig.9 Supply Current vs. Ambient Temperature

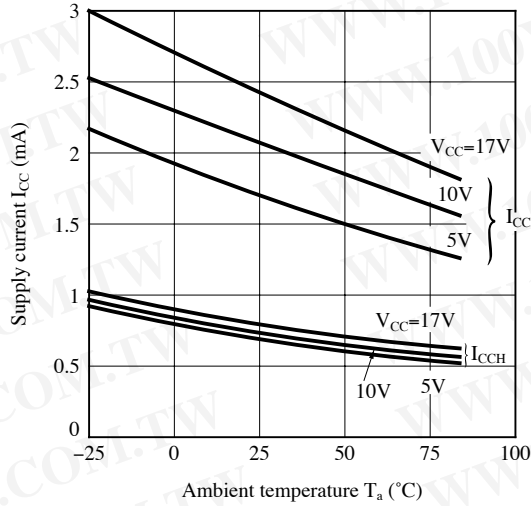


Fig.10 Propagation Delay Time vs. Forward Current

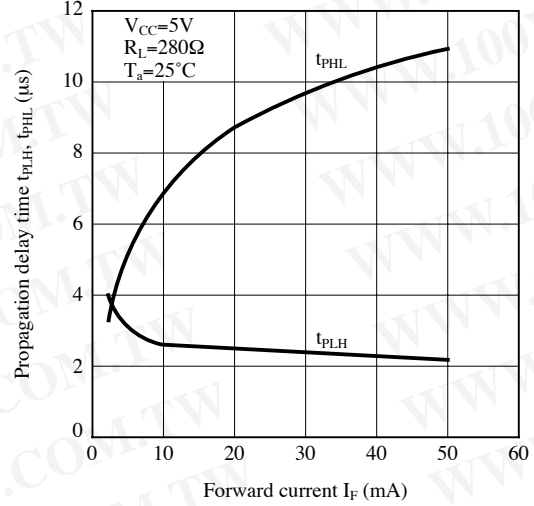


Fig.11 Rise Time, Fall Time vs. Load Resistance

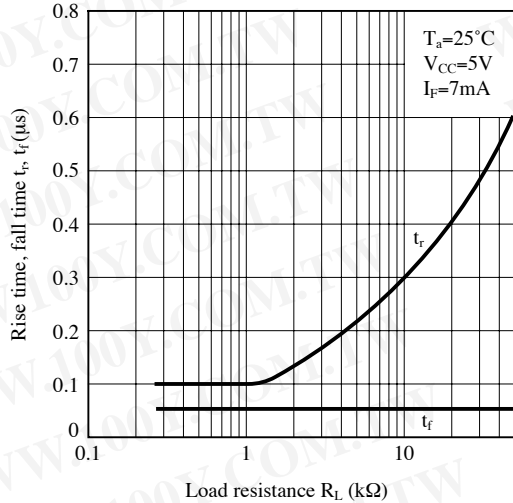
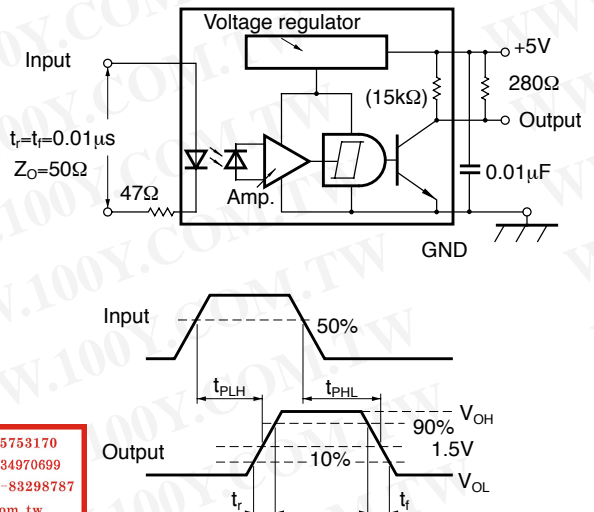


Fig.12 Test Circuit for Response Time



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Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.

■ Design Considerations

● Recommended operating conditions

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Output current	I_O	–	–	16	mA
Forward current	I_F	10	–	20	mA
Operating temperature	T_{opr}	0	–	70	°C

● Notes about static electricity

Transistor of detector side in bipolar configuration may be damaged by static electricity due to its minute design.

When handling these devices, general countermeasure against static electricity should be taken to avoid breakdown of devices or degradation of characteristics.

● Design guide

1) Prevention of detection error

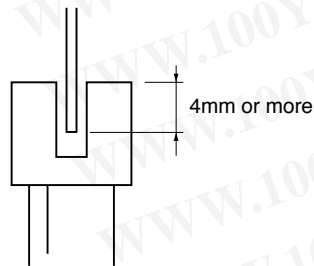
To prevent photointerrupter from faulty operation caused by external light, do not set the detecting face to the external light.

2) In order to stabilize power supply line, connect a by-pass capacitor of more than 0.01 μ F between V_{CC} and GND near the device.

3) Position of opaque board

Opaque board shall be installed at place 4mm or more from the top of elements.

(Example)



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This product is not designed against irradiation and incorporates non-coherent IRED.

● Degradation

In general, the emission of the IRED used in photocouplers will degrade over time.

In the case of long term operation, please take the general IRED degradation (50% degradation over 5 years) into the design consideration.

● **Parts**

This product is assembled using the below parts.

- **Photodetector (qty. : 1)** [Using a silicon photodiode as light detecting portion, and a bipolar IC as signal processing circuit]

Category	Maximum Sensitivity wavelength (nm)	Sensitivity wavelength (nm)	Response time (μs)
Photodiode	900	400 to 1 200	3

- **Photo emitter (qty. : 1)**

Category	Material	Maximum light emitting wavelength (nm)	I/O Frequency (MHz)
Infrared emitting diode (non-coherent)	Gallium arsenide (GaAs)	950	0.3

- **Material**

Case	Lead frame plating
Black NORYL resin	Solder dip. (Sn-3Ag-0.5Cu)

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- **Others**

Laser generator is not used.

■ Manufacturing Guidelines**● Soldering Method****Flow Soldering:**

Soldering should be completed below 260°C and within 5 s.

Please take care not to let any external force exert on lead pins.

Please don't do soldering with preheating, and please don't do soldering by reflow.

Hand soldering

Hand soldering should be completed within 3 s when the point of solder iron is below 350°C.

Please solder within one time.

Please don't touch the terminals directly by soldering iron.

Soldered product shall treat at normal temperature.

Other notice

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the cooling and soldering conditions.

Flux

Some flux, which is used in soldering, may crack the package due to synergistic effect of alcohol in flux and the rise in temperature by heat in soldering. Therefore, in using flux, please make sure that it does not have any influence on appearance and reliability of the photointerrupter.

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● Cleaning instructions**Solvent cleaning :**

Solvent temperature should be 45°C or below. Immersion time should be 3 minutes or less.

Ultrasonic cleaning :

The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.

Recommended solvent materials :

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

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● Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this product.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

This product shall not contain the following materials banned in the RoHS Directive (2002/95/EC).

- Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBB), Polybrominated diphenyl ethers (PBDE).

■ Package specification**● Case package****Package materials**

Anti-static plastic bag : Polyethylene

Moltopren : Urethane

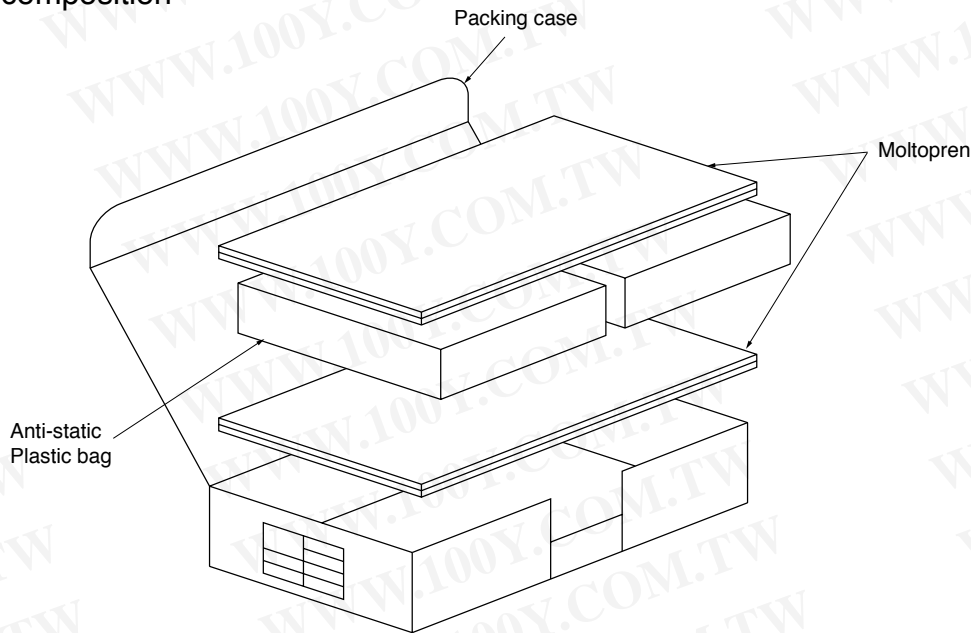
Packing case : Corrugated fiberboard

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Package method

50 pcs of products shall be packaged in a plastic bag, Ends shall be fixed by stoppers. The bottom of the packing case is covered with moltopren, and 2 plastic bags shall be put into the packing case.

Moltopren should be located after all product are settled (1 packing contains 100 pcs).

Packing composition

■ Important Notices

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(i) The devices in this publication are designed for use in general electronic equipment designs such as:

- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

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